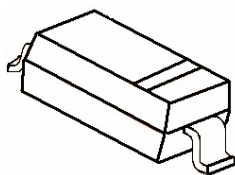
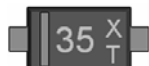


SOD-123

350mW SOD-123 Fast Switching Diode



MARKING: 35XT



特征 Features

- 开关速度小于 100nS; Fast Switching Device (TRR <100nS)
- 最大功率耗散 350mW; Power Dissipation of 350mW
- 高稳定性和可靠性。High Stability and High Reliability
- 反向漏电流小。Low reverse leakage

机械数据 Mechanical Data

- 封装: SOD-123 封装 SOD-123 Small Outline Plastic Package
- 极性: 色环端为负极 Polarity: Color band denotes cathode end
- 环氧树脂 UL 易燃等级 Epoxy UL: 94V-0
- 安装位置: 任意 Mounting Position: Any

极限值和温度特性(TA = 25℃ 除非另有规定)

Maximum Ratings & Thermal Characteristics (Ratings at 25℃ ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	数值 Value	单位 Unit
反向电压 Reverse Voltage	V _R	350	V
反向峰值电压 Peak Reverse Voltage	V _{RM}	350	V
功率消耗 Power Dissipation	P _d	350	mW
工作结温 Operating junction temperature	T _j	150	℃
存储温度 Storage temperature range	T _s	-65~+150	℃
反向工作电压 Working Inverse Voltage	W _{IV}	75	V
平均整流电流 Average Rectified Current	I _o	225	mA
典型热阻 Typical thermal resistance	R _{θJA} R _{θJC}	250 5	℃/W
正向(不重复)电流 Non-repetitive Peak Forward Current	I _{FM}	300	mA
正向(不重复)浪涌电流 Peak Forward Surge Current	I _{FSM}	1.0	A

@tp=1us; TA=25℃

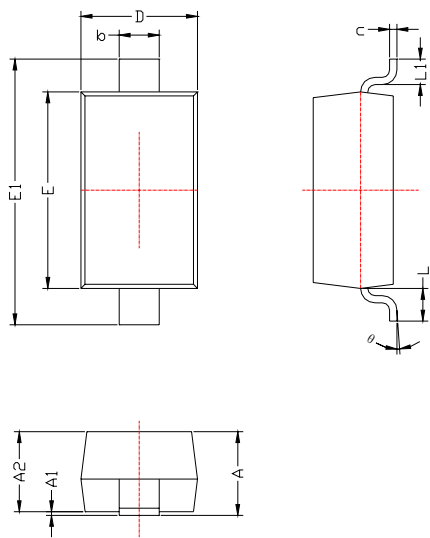
Valid provided that electrodes are kept at ambient temperature.

电特性 Electrical Characteristics (Ratings at 25℃ ambient temperature unless otherwise specified).

符号 Symbols	参数 Parameter	测试条件 Test Condition	界限 Limits		单位 Unit
			Min	Max	
VRB	反向击穿电压 Reverse Voltage	IB=100uA	350	---	V
IR	反向漏电流 Reverse Leakage Current	VR=240V	---	100	nA
VF	正向电压 Forward Voltage	IF=20mA	---	0.87	V
		IF=100mA	---	1.00	
		IF=200mA	---	1.25	
TRR	反向恢复时间 Reverse Recovery Time	IF= 30mA, IR=30mA RL=100Ω IRR=3mA	---	100	nS
C	结电容 Capacitance	VR=0V, f=1MHZ	---	5	pF

SOD-123 PACKAGE OUTLINE

Plastic surface mounted package

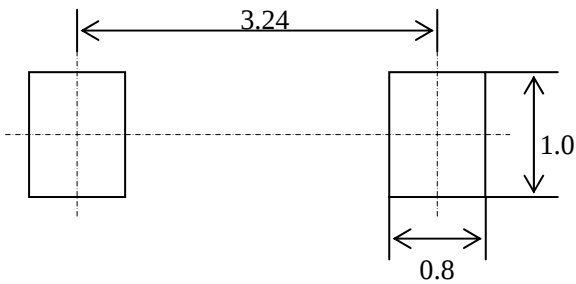


SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.450	0.650
c	0.080	0.150
D	1.500	1.700
E	2.600	2.800
E1	3.550	3.850
L	0.500REF	
L1	0.250	0.450
θ	0°	8°

焊盘设计参考

Precautions: PCB Design

Recommended land dimensions for SOD-123 diode. Electrode patterns for PCBs



技术要求:

- 1, 塑封体尺寸: 2.70 X 1.60
- 2: 未注公差为: ±0.05
- 3, 所有单位: mm